

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT7129033

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
BIJAN KUMAR MOHANTY	01/18/2022
DIVYA MADDI	01/17/2022
HUNG T. DINH	01/14/2022
VIKRAM RAMDEV BOKKA	01/17/2022
<b>RECEIVING PARTY DATA</b>	
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<b>Street Address:</b>	ONE DELL WAY
<b>City:</b>	ROUND ROCK
<b>State/Country:</b>	TEXAS
<b>Postal Code:</b>	78682
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17579104
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(203)255-6570
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<b>ATTORNEY DOCKET NUMBER:</b>	127074.01
<b>NAME OF SUBMITTER:</b>	MICHAEL J. COOPER
<b>SIGNATURE:</b>	/Michael J. Cooper/
<b>DATE SIGNED:</b>	01/19/2022
<b>Total Attachments: 6</b>	
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**PATENT**

**REEL: 058697 FRAME: 0448**

## ASSIGNMENT

**WHEREAS**, we, Bijan Kumar Mohanty, Divya Maddi, Hung T. Dinh, and Vikram Ramdev Bokka have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled **AUTOMATICALLY CLASSIFYING CLOUD INFRASTRUCTURE COMPONENTS FOR PRIORITIZED MULTI-TENANT CLOUD ENVIRONMENT RESOLUTION USING ARTIFICIAL INTELLIGENCE TECHNIQUES**, the specification of which:

☒ [X] is being executed on even date herewith and is about to be filed in the United States Patent Office;

☐ [ ] was filed on \_\_\_\_\_ as U.S. Application No. \_\_\_\_\_;

☐ [ ] was patented under U.S. Patent No. \_\_\_\_\_ on \_\_\_\_\_.

**WHEREAS**, Dell Products L.P. (hereinafter "ASSIGNEE"), a limited partnership organized and existing under the laws of the State of Texas and having a usual place of business at One Dell Way, Round Rock, Texas 78682 desires to acquire an interest therein in accordance with agreements duly entered into with us;

**NOW, THEREFORE**, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

**AND**, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its

successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

**AND**, we do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives.

**IN TESTIMONY WHEREOF**, we have hereunto set our hands and affixed our seals as set forth below:

Date: 01/18/2022



\_\_\_\_\_  
Inventor's Signature

Full name of first inventor:

Bijan Kumar Mohanty

Residence:

Austin, Texas

Citizenship:

United States of America

Mailing Address:

12525 Belcara Place  
Austin, Texas 78732

Date: \_\_\_\_\_

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Inventor's Signature

Full name of second inventor:

Divya Maddi

Residence:

Round Rock , Texas

Citizenship:

United States of America

Mailing Address:

4911 Bruco Lane  
Round Rock, Texas 78665

Date: \_\_\_\_\_

\_\_\_\_\_  
Inventor's Signature

Full name of third inventor:

Hung T. Dinh

Residence:

Austin, Texas

Citizenship:

United States of America

Mailing Address:

1809 Maize Bend Drive  
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Date:

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Inventor's Signature

Full name of first inventor:

Bijan Kumar Mohanty

Residence:

Austin, Texas

Citizenship:

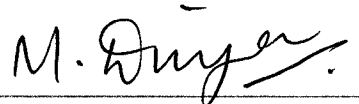
United States of America

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Inventor's Signature

Full name of second inventor:

Divya Maddi

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Full name of third inventor:

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Date:

1/14/2022



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Inventor's Signature

Full name of third inventor:

Hung T. Dinh

Residence:

Austin, Texas

Citizenship:

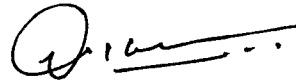
United States of America

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Date:

01/17/2022



\_\_\_\_\_  
Inventor's Signature

Full name of fourth inventor:

Vikram Ramdev Bokka

Residence:

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Citizenship:

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